# **3.3 V USB 3.1 Single** Channel Re-driver

#### Description

The NB7NPQ701M is a 3.3 V single channel re-driver for USB 3.1 Gen 1 and USB 3.1 Gen 2 applications that supports both 5 Gbps and 10 Gbps data rates. Signal integrity degrades from PCB traces, transmission cables, and inter-symbol interference (ISI). The NB7NPQ701M compensates for these losses by engaging varying levels of equalization at the input receiver and de-emphasis on output driver. The output transmitter circuitry provides user selectable de-emphasis and output amplitude settings to create the best eye openings for the outgoing data signals.

The NB7NPQ701M features an intelligent LFPS circuit. This circuit senses the low frequency signals and automatically disables driver de–emphasis for full USB 3.1 Gen 1 and USB 3.1 Gen 2 compliances.

After power up, the NB7NPQ701M periodically checks both of the TX output pairs for a receiver connection. When the receiver is detected the RX termination becomes enabled and the NB7NPQ701M is set to perform the re-driver function.

The NB7NPQ701M comes in a small,  $2 \ge 2 \mod \text{WDFN8}$  package and is specified to operate across the entire industrial temperature range,  $-40^{\circ}$ C to  $85^{\circ}$ C.

#### Features

- 3.3 V  $\pm$  5% Power Supply
- Device Supports USB 3.1 Gen 1 and USB 3.1 Gen 2 Data Rates
- Automatic LFPS De-Emphasis Control
- Automatic Receiver Termination Detection
- Integrated Input and Output Termination
- Selectable Equalization, De-Emphasis, and Output Swing
- Hot-Plug Capable
- ESD Protection ±4 kV HBM
- Operating Temperature Range: -40°C to 85°C
- Small 2 x 2 x 0.8 mm WDFN8 Package
- This is a Pb–Free Device

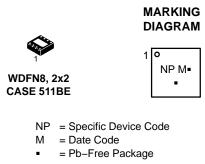
#### **Typical Applications**

- Computer and Laptop
- Docking Station and Dongle
- Active Cable, Back Planes
- Gaming Console, Smart T.V.
- Servers and Storage



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(Note: Microdot may be in either location)

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
NB7NPQ701MMTTBG	WDFN8 (Pb–Free)	3000 / Tape & Reel

<sup>+</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

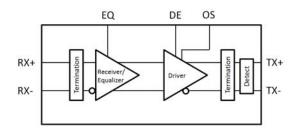


Figure 1. Logic Diagram of NB7NPQ701M

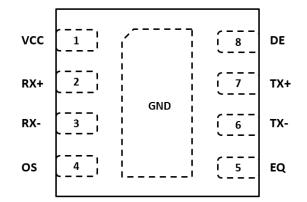


Figure 2. WDFN8 Package Pinout (Top View)

#### Table 1. PIN DESCRIPTION

Pin Number	Pin Name	Туре	Description
1	VCC	Power	3.3 V power supply
2	RX+	DIFF IN	Differential input pair for 5 / 10 Gbps USB signals. Must be externally AC-coupled.
3	RX-		
4	OS	LVCMOS IN	Sets output swing on the TX. The 3–state input with integrated 250 k $\Omega$ pull–up and pull–down resistors.
5	EQ	LVCMOS IN	Sets the receiver equalizer gain. The 3–state input with integrated 250 k $\Omega$ pull–up and pull–down resistors.
6	TX-	DIFF OUT	Differential output for 5 / 10 Gbps USB signals. Must be externally AC-coupled.
7	TX+		
8	DE	LVCMOS IN	Sets the output de–emphasis gain. The 3–state input with integrated 250 k $\Omega$ pull–up and pull–down resistors.
EP	GND	GND	Exposed Pad (EP) on the package bottom is thermally and electronically connected to the die. The exposed pad must electrically connected to GND.

## **DEVICE CONFIGURATION**

## Table 2. CONTROL PIN EFFECTS (Typical Values)

Pin	Description	Logic State	E	Equalization Gain			
EQ	Equalization Amount	Low		3 dB			
		Mid		6 dB			
		High		9 dB			
			De-emphasis Ratio (Note 1)				
Pin	Description	Logic State	OS = LOW	OS = Float	OS = High		
DE	De-Emphasis Amount	Low	0 dB	–4.5 dB	–6.5 dB		
		Mid	-4 dB	–6 dB	–7.5 dB		
		High	-6 dB	–7.5 dB	–8 dB		
Pin	Description	Logic State		Output Swing			
OS	Output Swing with DE Pin Low	Low		850 mV <sub>PP</sub>			
	(0 dB)	Mid	1050 mV <sub>PP</sub>				
		High		1200 mV <sub>PP</sub>			

1. dB Decrease = 20 log \* (VTX-DE / VTX-DIFF-PP)

### Table 3. ATTRIBUTES

Parameter		
ESD Protection	Human Body Model Charged Device Model	> 4 kV > 1.5 kV
Moisture Sensitivity, Indefinite Time Out of Drypack (Note 2)		Level 1
Flammability Rating	Oxygen Index: 28 to 34	UL 94 V-O @ 0.125 in
Transistor Count		703
Meets or exceeds JEDEC Spec EIA/JESD78 IC Latchup Test		

2. For additional information, see Application Note AND8003/D.

#### Table 4. ABSOLUTE MAXIMUM RATINGS

Over operating free-air temperature range (unless otherwise noted)

Parameter	Description	Min	Max	Unit
Supply Voltage (Note 3)	V <sub>CC</sub>	-0.5	4.6	V
Voltage range at any input or	Differential I/O	-0.5	1.89	V
output terminal	LVCMOS inputs	-0.5	V <sub>CC</sub> + 0.5	V
Storage Temperature Range, T <sub>SG</sub>		-65	150	°C
Maximum Junction Temperature, T <sub>J</sub>			125	°C
Operating Ambient Temperature Range, T <sub>A</sub>		-40	85	°C
Junction–to–Ambient Thermal Resistance @ 500 lfm, $\theta_{JA}$ (Note 4)			62	°C/W
Wave Solder, Pb–Free, T <sub>SOL</sub>			265	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

3. All voltage values are with respect to the GND terminals.

4. JEDEC standard multilayer board – 2S2P (2 signal, 2 power).

#### Table 5. RECOMMENDED OPERATING CONDITIONS

Over operating free-air temperature range (unless otherwise noted)

Parameter	Description	Min	Nom	Max	Unit
V <sub>CC</sub>	Main power supply	3.135	3.3	3.465	V
T <sub>A</sub>	Operating free–air temperature	-40		+85	°C
C <sub>AC</sub>	AC coupling capacitor	75	100	265	nF

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

## Table 6. POWER SUPPLY CHARACTERISTICS

	Parameter	Test Conditions	Min	Typ (Note 5)	Max	Unit
	Active	Link in U0 with SS data transmission DE = low 0 dB, EQ = low 3 dB, OS = low		70		mA
I <sub>CC</sub>	Idle State	Link has some activity, not in U0 DE = mid $-4$ dB, EQ = mid 6dB OS = low		50		mA
	U2/U3	Link in U2 or U3 power saving state DE = mid –4 dB, EQ = mid 6 dB, OS = low		6.7		mA
	No USB Connection	No connection state, termination disabled DE = mid $-4$ dB, EQ = mid 6 dB, OS = low		6.7		mA

5. TYP values use V\_{CC} = 3.3 V,  $T_{A}$  = 25°C.

### Table 7. LVCMOS CONTROL PIN CHARACTERISTICS

Parameter		Test Conditions	Min	Тур	Max	Unit			
3–State LVCMO	3-State LVCMOS Inputs (EQ, DE, OS)								
V <sub>IH</sub>	High-level input voltage		0.8 * V <sub>CC</sub>		V <sub>CC</sub>	V			
V <sub>IM</sub>	Mid-level input voltage		0.4 * V <sub>CC</sub>	V <sub>CC</sub> / 2	0.6 * V <sub>CC</sub>	V			
V <sub>IL</sub>	Low-level input voltage		GND		0.2 * <sup>V</sup> CC	V			
V <sub>F</sub>	Floating voltage	V <sub>IN</sub> = High impedance		V <sub>CC</sub> / 2		V			
R <sub>PU</sub>	Internal pull-up resistance			250		kΩ			
R <sub>PD</sub>	Internal pull-down resistance			250		kΩ			
Ι <sub>ΙΗ</sub>	High-level input current	V <sub>IN</sub> = 1.89 V			20	μΑ			
I <sub>IL</sub>	Low-level input current	$V_{IN} = GND, V_{CC} = 3.3 V$	-20			μΑ			

	Parameter	Test Conditions	Min	Тур	Max	Unit
VRX-DIFF-pp	Input differential voltage swing	AC-coupled, peak-to-peak	250		1200	mV <sub>PP</sub>
VRX-CM	Common-mode voltage bias in the receiver (DC)			V <sub>CC</sub> - 0.25		V
ZRX-DIFF	Differential input impedance (DC)	Present after an USB device is detected on TX+/TX-	80	100	120	Ω
ZRX-CM	Common-mode input impedance (DC)	Present after an USB device is detected on TX+/TX-	20	25	30	Ω
ZRX-HIGH-IMP	Common-mode input impedance with termination disabled (DC)	Present when no USB device is detected on TX+	25	35		kΩ
VTH-LFPS-pp	Low Frequency Periodic Signaling (LFPS) Detect Threshold	Output voltage is considered squelched below this threshold voltage.			300	mV <sub>PP</sub>

### Table 8. RECEIVER AC/DC CHARACTERISTICS Over operating free-air temperature range (unless otherwise noted)

### Table 9. TRANSMITTER AC/DC CHARACTERISTICS Over operating free-air temperature range (unless otherwise noted)

	Parameter	Test Conditions	Min	Тур	Max	Unit
VTX-DIFF-PP	Output differential voltage swing at 5	OS = Low, 50 $\Omega$ to V <sub>CC</sub>		850		mV <sub>PP</sub>
	Gbps, 10 Gbps with DE low	OS = Mid, 50 $\Omega$ to V <sub>CC</sub>		1050		
		OS = High, 50 $\Omega$ to V <sub>CC</sub>		1200		
СТХ	TX input capacitance to GND	At 2.5 GHz		1.25		pF
ZTX-DIFF	Differential output impedance (DC)	Present after an USB device is de- tected on TX+/TX-	80	100	120	Ω
ZTX-CM	Common-mode output impedance (DC)	Present after an USB device is de- tected on TX+/TX-	20		30	Ω
ITX-SC	TX short circuit current	TX+ or TX- shorted to GND		60		mA
VTX-CM	Common-mode voltage bias in the transmitter (DC)			V <sub>CC</sub> -0.5	V <sub>CC</sub>	V
VTX-CM-ACpp	AC common-mode peak-to-peak volt- age swing in active mode	Within U0 and within LFPS			100	mV <sub>PP</sub>
VTX-IDLE-DIFF- ACpp	Differential voltage swing during electrical idle	Tested with a high–pass filter	0		10	mV <sub>PP</sub>
VTX-RXDET	Voltage change to allow receiver detect	Positive voltage to sense receiver termination			600	mV
t <sub>R</sub> , t <sub>F</sub>	Output rise, fall time	20% – 80% of differential voltage measured 1 inch from the output pin		45		ps
t <sub>RF-MM</sub>	Output rise, Fall time mismatch	20% – 80% of differential voltage measured 1 inch from the output pin			5	ps
t <sub>diff-LH</sub> , t <sub>diff-HL</sub>	Differential propagation delay	De-emphasis = -4 dB, OS = Low propagation delay between 50% level at input and output		150		ps
t <sub>idleEntry</sub> , <sup>t</sup> idleExit	Idle entry and exit times			30		ns

#### **Table 10. TIMING AND JITTER CHARACTERISTICS**

10		ms
	10	10

UI

(Note 8)

UI

(Note 8)

UI

(Note 8)

#### 0.076 Total jitter (Notes 6, 7) TJTX-EYE EQ = Mid 6 dB, DE = High - 6 dB,DJTX Deterministic jitter (Note 7) 0.046 OS = Low 0.004 RJTX Random jitter (Note 7)

#### JITTER FOR 10 Gbps

TJTX-EYE	Total jitter (Notes 6, 7)	EQ = Mid 6dB, DE = High −6 dB, OS = Low	0.053	UI (Note 8)
DJTX	Deterministic jitter (Note 7)		0.008	UI (Note 8)
RJTX	Random jitter (Note 7)		0.001	UI (Note 8)

6. Includes RJ at  $10^{-12}$ .

Measured at the ends of reference channel with a K28.5 pattern, VID = 1000 mVpp, -3.5 dB de-emphasis from source.
 5 Gbps, UI = 200 ps for 10 Gbps, UI = 100 ps.

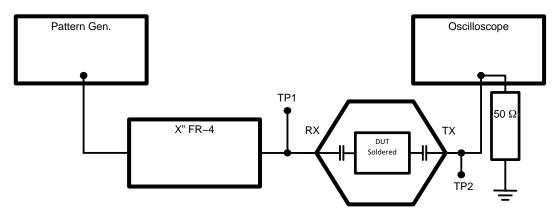


Figure 3. Equalization Measurement Setup

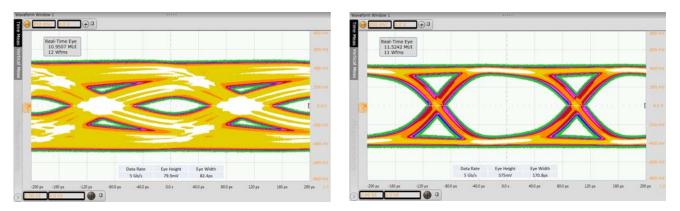


Figure 4. 5 Gbps Signal with 24 inches of FR4 Before Input (Figure 3 TP1) to NB7NPQ701M and After (Figure 3 TP2) Using High EQ Setting

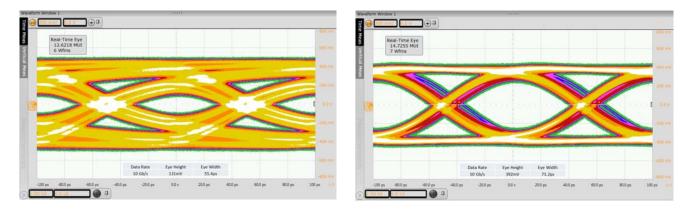
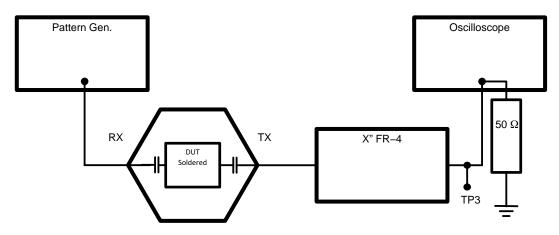
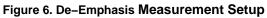


Figure 5. 10 Gbps Signal with 12 inches of FR4 Before Input (Figure 3 TP1) to NB7NPQ701M and After (Figure 3 TP2) with EQ Floating (Mid)





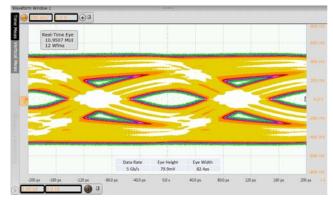


Figure 7. 5 Gbps Signal After 24 inches of FR4 (No DUT)

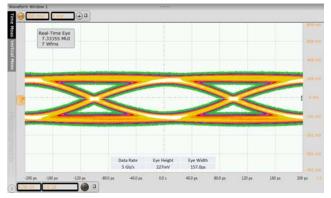


Figure 8. 5 Gbps Signal After 24 inches of FR4 at Output (Figure 6 TP3) with Mid DE Setting to NB7NPQ701M

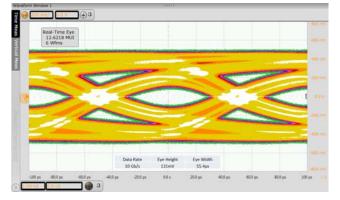


Figure 9. 10 Gbps Signal After 12 inches of FR4 (No DUT)

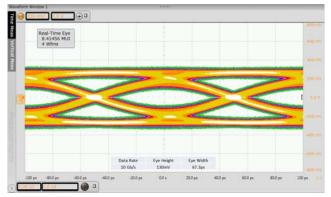


Figure 10. 10 Gbps Signal After 12 inches of FR4 at Output (Figure 6 TP3) with Low DE Setting to NB7NPQ701M

#### PARAMETER MEASUREMENT DIAGRAMS

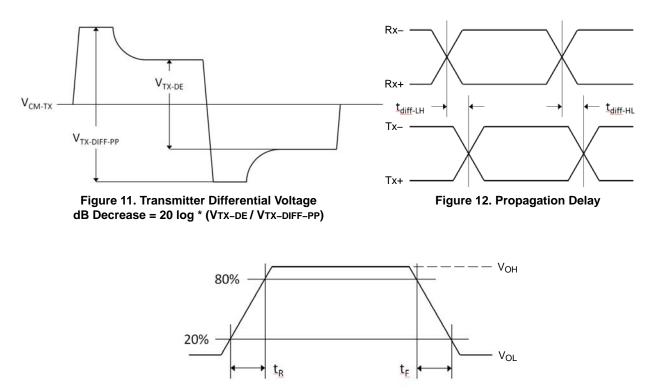


Figure 13. Output Rise and Fall Times

### **APPLICATION GUIDELINES**

#### LFPS Compliance Testing

As part of USB 3.1 compliance test, the host or peripheral must transmit a LFPS signal that adheres to the spec parameters. When using a real-time oscilloscope to capture this data, *the scope's trigger must be below 0 V when making single-ended measurements*. Although the differential signal is identical to that which is expected by the USB 3.1 system, the AC common mode voltage for LFPS may fall below 0 V during short bursts of switching signal, which is still within the spec's limit.

#### **LFPS Functionality**

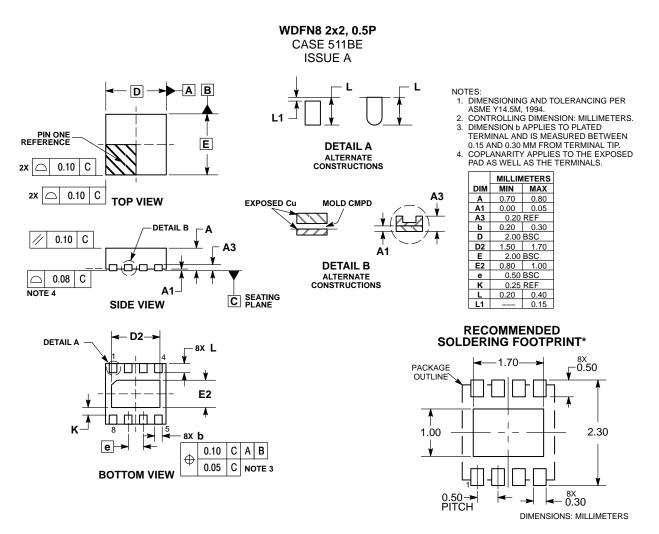
USB 3.1 links use Low Frequency Periodic Signaling (LFPS) to implement functions like exiting low-power modes, performing warm resets and providing link training

between host and peripheral devices. LFPS signaling consists of bursts of frequencies ranging between 10 to 50 MHz and can have specific burst lengths or repeat rates.

#### Ping.LFPS for TX Compliance

During the transmitter compliance, the system under test must transmit certain compliance patterns as defined by the USB–IF. In order to toggle through these patterns for various tests, the receiver must receive a ping. LFPS signal from either the test suite or a separate pattern generator. The standard signal comprises of a single burst period of 100ns at 20 MHz. In order to pass this signal through NB7NPQ701M, *the duration of the burst must be extended to at least 200 ns.* 

#### PACKAGE DIMENSIONS



\*For additional information on our Pb–Free strategy and solderin details, please download the ON Semiconductor Soldering ar Mounting Techniques Reference Manual, SOLDERRM/D.

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